IN THE CLAIMS

Please amend the claims as follows:

(original) A wafer, comprising:
 protein material, wherein said protein material comprises, by weight, between about 26% and about 99% of a wafer.

2. (original) The wafer of claim 1, further comprising:flavorings or seasonings;oil; andan emulsifier.

- 3. (original) The wafer of claim 1, wherein said protein material is whey protein, wheat protein, soy protein, calcium caseinate, egg white protein or a combination thereof.
 - 4. (original) The wafer of claim 1, comprising:
 caseinate; and
 whey protein isolate;
 wherein the ratio of caseinate to whey protein isolate is about 1:5.4 to about 1:5.7.
 - 5. (original) The wafer of claim 1, comprising: whey protein isolate; and soy protein isolate.
- 6. (original) The wafer of claim 5, wherein the ratio of soy protein isolate to whey protein isolate ranges from about 1:1 to about 1:4.
 - 7. (original) A wafer, comprising by weight: up to about 99% whey protein isolate;

up to about 99% soy protein isolate; up to about 11% calcium caseinate; and up to about 23% egg white protein.

- 8. (original) The wafer of claim 7, wherein: whey protein isolate comprises about 60%; soy protein isolate comprises about 15%; calcium caseinate comprises about 11%; and egg white protein comprises about 8%.
- 9. (original) The wafer of claim 7, further comprising up to about 99% by weight wheat protein.
 - 10. (original) A wafer, comprising:
 at least one protein material; and
 starch;
 wherein said starch comprises up to about 65% of a wafer.
- 11. (original) The wafer of claim 10, wherein said starch is pastry flour, Himaize flour or wheat flour.
- 12. (original) The wafer of claim 10, wherein:
 said at least one protein material comprises about 26% by weight of said wafer;
 and
 said starch comprises about 64% by weight of said wafer.
 - 13. (original) The wafer of claim 10, wherein said protein material comprises: whey protein isolate comprising about 11% by weight of said wafer; soy protein isolate comprising about 11% by weight of said wafer; calcium caseinate comprising about 2% by weight of said wafer; and egg white proteins comprising about 2% by weight of said wafer.

- 14. (original) The wafer of claim 13, further comprising wheat proteins.
- 15. (withdrawn) A base wafer batter, comprising;

protein material; and

water;

wherein said protein material comprises up to about 65% of a base wafer batter;

and

wherein said water comprises up to about 60% of said base wafer batter.

- 16. (withdrawn) The base wafer batter of claim 15, wherein the ratio of said protein material to said water ranges from about 1:1.5 to about 1:2.
 - 17. (withdrawn) A base wafer batter, comprising:

protein material;

starch; and

water;

wherein said protein material comprises up to about 65% of said base wafer batter;

said starch comprises up to about 30% of said base wafer batter; and said water comprises up to about 60% of said base wafer batter.

- 18. (withdrawn) The base wafer batter of claim 17, wherein: said protein material comprises about 12% by weight of said batter; said starch comprises about 30% by weight of said batter; and said water comprises about 54% by weight of said batter.
- 19. (withdrawn) A snack food, comprising a protein enhanced wafer, wherein said wafer comprises up to about 99% protein.

20. (withdrawn) The snack food of claim 19, further comprising:

a cream filling;

chocolate;

an icing; or

a combination thereof.

21. (withdrawn) A method for making a wafer, comprising:

making a base wafer batter; and

baking said batter;

wherein said batter comprises up to about 65% protein, and wherein whey protein is added to said batter before soy protein is added to said batter.

- 22. (withdrawn) The method of claim 21, wherein said batter bakes at a temperature from about 140°C to about 165°C and for a time period from about 1.5 minutes to about 2.5 minutes.
- 23. (withdrawn) A method for making a base wafer batter, comprising: first making a solution of water, egg whites and emulsifiers; and then combining proteins, wherein whey protein is added and mixed before soy protein is added and mixed.
- 24. (withdrawn) The method of claim 23, further comprising adding and mixing wheat protein after whey protein is added and mixed and before soy protein is added and mixed.
- 25. (withdrawn) The method of claim 23, wherein caseinate is added and mixed before whey protein is added and mixed.
- 26. (withdrawn) The method of claim 23, further comprising adding and mixing salt, seasonings, flavorings, or a combination thereof.

- 27. (withdrawn) A method for making a base wafer batter, comprising: making a protein slurry; making a starch slurry; and mixing together said protein slurry with said starch slurry.
- 28. (withdrawn) The method of claim 27, wherein said protein slurry is made by:

first mixing together water and egg whites;
then adding oil and an emulsifier to the mixture and mixing;
then adding caseinate and mixing;
then adding protein and mixing, wherein whey protein is added and mixed before
soy protein is added and mixed; and
wherein said starch slurry is made by:
combining water, starch, an emulsifier, oil, salt and a leavening agent and mixing.

- 29. (withdrawn) The method of claim 28, further comprising adding and mixing wheat protein after whey protein is added and mixed and before soy protein is added and mixed.
 - 30. (withdrawn) A method for making a snack food, comprising: making a protein enhanced, low carbohydrate wafer; forming said wafer; and coating, filling or dressing said wafer with a cream filling, icing or chocolate; wherein said wafer is made by the method of claim 21.
 - 31. (withdrawn) A method for making a snack food, comprising: making a protein enhanced, low carbohydrate wafer; forming said wafer; and coating, filling or dressing said wafer with a cream filling, icing or chocolate; wherein said wafer is made by the method of claim 22.

- 32. (withdrawn) A method for making a snack food, comprising: making a protein enhanced, low carbohydrate wafer; forming said wafer; and coating, filling or dressing said wafer with a cream filling, icing or chocolate; wherein said wafer is made by the method of claim 23.
- 33. (withdrawn) A method for making a snack food, comprising: making a protein enhanced, low carbohydrate wafer; forming said wafer; and coating, filling or dressing said wafer with a cream filling, icing or chocolate; wherein said wafer is made by the method of claim 24.
- 34. (withdrawn) A method for making a snack food, comprising: making a protein enhanced, low carbohydrate wafer; forming said wafer; and coating, filling or dressing said wafer with a cream filling, icing or chocolate; wherein said wafer is made by the method of claim 25.
- 35. (withdrawn) A method for making a snack food, comprising: making a protein enhanced, low carbohydrate wafer; forming said wafer; and coating, filling or dressing said wafer with a cream filling, icing or chocolate; wherein said wafer is made by the method of claim 26.
- 36. (withdrawn) A method for making a snack food, comprising: making a protein enhanced, low carbohydrate wafer; forming said wafer; and coating, filling or dressing said wafer with a cream filling, icing or chocolate; wherein said wafer is made by the method of claim 27.

- 37. (withdrawn) A method for making a snack food, comprising: making a protein enhanced, low carbohydrate wafer; forming said wafer; and coating, filling or dressing said wafer with a cream filling, icing or chocolate; wherein said wafer is made by the method of claim 28.
- 38. (withdrawn) A method for making a snack food, comprising: making a protein enhanced, low carbohydrate wafer; forming said wafer; and coating, filling or dressing said wafer with a cream filling, icing or chocolate; wherein said wafer is made by the method of claim 29.
- 39. (canceled)
- 40. (original) A wafer, comprising:
 up to about 27 grams of protein per 28 grams of said wafer; and
 up to about 4 grams of carbohydrates per 28 grams of said wafer.
- 41. (withdrawn) A snack food comprising:
 a wafer;
 wherein said snack food comprises up to about 19 grams of protein per 28 grams of said snack food.
 - 42. (withdrawn) A snack food, comprising: a wafer;

wherein said snack food comprises up to about 9 grams of carbohydrates per 28 grams of said snack food.